| ASSOCIATION CONNECTING<br>ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES®<br>international and Pa | IPC. Bannockl                  | ourn, Illinois, A            | Il rights reserved untions. | under both  | This docume<br>level parts, t | ent is a declaration entite the declaration e | on of the su<br>compasses                   | bstances v<br>s all lower | vithin the manufactu<br>level materials for v | urer listed which the   | item. Note:<br>manufacture      | if the item is an as<br>er has engineering | sembly with low responsibility. |  |
|---|--------------------------------|------------------------------|-----------------------------|---|-------------------------------|--|---|---------------------------|---|-------------------------|---------------------------------|--|---------------------------------|--|
|   |                                |                              | Form Type<br>Distribute     | * Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Materia |                               |  |   |                           | rials and N                                   | als and Mfg Information |                                 |  |                                 |  |
| upplier Information   |                                |                              |                             |   |                               |  |   |                           |   |                         |                                 |  |                                 |  |
| Company name* Comp  |                                |                              | Company unique ID           |   |                               | Unique ID Authority  |   |                           |   | Respon                  | Response Date*                  |  |                                 |  |
| onsemi  |                                |                              |                             |   |                               |  |   |                           |   |                         | 2024-05-10                      |  |                                 |  |
| Contact Name Title - Contact  |                                |                              |                             | Phone - Contact*  |                               |  |   | Email                     | Email - Contact*                              |                         |                                 |  |                                 |  |
| Product-Env-Stewards Product En   |                                |                              | act Enviro Compliance       |   |                               | NA   |   |                           |   | Produ                   | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Authorized Representative* Title - Repre  |                                |                              | resentative                 |   |                               | Phone - Representative*  |   |                           |   | Email                   | Email - Representative*         |  |                                 |  |
| Product-Env-Stewards Pro  |                                |                              | Product Enviro Compliance   |   |                               | NA   |   |                           |   | Produ                   | Product-Env-Stewards@onsemi.com |  |                                 |  |
| Requester Item Number   | Requester Item Number Mfr Iten |                              | n Number Mfr Item Name      |   |                               | Effective Date   | ve Date Version Manufacturing Site          |                           |   | Weight*                 | UOM                             | Unit Type                                  |                                 |  |
|   | NSI4502                        | NSI45020JZT1G SOT223 EUTECTI |                             | TIC 20MA  |                               | 2024-05-10   |   | М                         | MY1   |                         | 109.99                          | mg   | Each                            |  |
| Ianufacturing Proccess Informa  | ition                          |                              |                             |   |                               |  | ·   |                           |   |                         |                                 |  |                                 |  |
| Terminal Plating / Grid Array M   | aterial                        | rial Terminal Base Alloy     |                             | J-STD-020 MSL   | MSL Rating Pe                 |  | ak Process Body Temperature Max Time at Pea |                           | k Tempera                                     | ature Num               | nber of Reflow Cyc              | eles                                       |                                 |  |
| Matte Tin (Sn) - annealed CU Allog  |                                | CU Alloy                     | 1                           |   |                               | 260 C  |   | С                         | 30 seco                                       |                         | seconds 3                       |  |                                 |  |
| omments   |                                |                              |                             |   |                               |  |   |                           |   |                         |                                 |  |                                 |  |
| vel 1 - maximum time at peak temperat   | ure during so                  | ldering is 10-3              | 0 seconds                   |   |                               |  |   |                           |   |                         |                                 |  |                                 |  |
| or more information regarding material  | composition                    | please refer to              | page 3                      |   |                               |  |   |                           |   |                         |                                 |  |                                 |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>y others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

| sigma range of distribution unless otherwise noted). |        |                 |          |                              |            |        |         |                 |  |
|--|--------|-----------------|----------|------------------------------|------------|--------|---------|-----------------|--|
| Homogeneous Material                                 | Weight | Unit of Measure | Level    | Substance                    | CAS        | Exempt | Weight  | Unit of Measure |  |
| Die  | 3.3    | mg              | Supplier | Silicon (Si)                 | 7440-21-3  |        | 3.3     | mg              |  |
| Lead Frame   | 39.54  | mg              | Supplier | Silver (Ag)                  | 7440-22-4  |        | 0.514   | mg              |  |
|  |        |                 | Supplier | Zinc (Zn)                    | 7440-66-6  |        | 0.0395  | mg              |  |
|  |        |                 | Supplier | Iron (Fe)                    | 7439-89-6  |        | 0.949   | mg              |  |
|  |        |                 | Supplier | Copper (Cu)                  | 7440-50-8  |        | 38.0375 | mg              |  |
| Mold Compound-Black                                  | 59.7   | mg              | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2 |        | 5.97    | mg              |  |
|  |        |                 | Supplier | Carbon Black (C)             | 1333-86-4  |        | 0.2985  | mg              |  |
|  |        |                 | Supplier | Aluminum Hydroxide (Al(OH)3) | 21645-51-2 |        | 8.6565  | mg              |  |
|  |        |                 | Supplier | Fused Silica (SiO2)          | 60676-86-0 |        | 38.805  | mg              |  |
|  |        |                 | Supplier | Phenolic Resin (Novolac)     | 9003-35-4  |        | 5.97    | mg              |  |
| Plating  | 7.44   | mg              | Supplier | Tin (Sn)                     | 7440-31-5  |        | 7.44    | mg              |  |
| Wire Bond - Cu                                       | 0.01   | mg              | Supplier | Copper (Cu)                  | 7440-50-8  |        | 0.01    | mg              |  |